

100V N-Channel MOSFET

Description

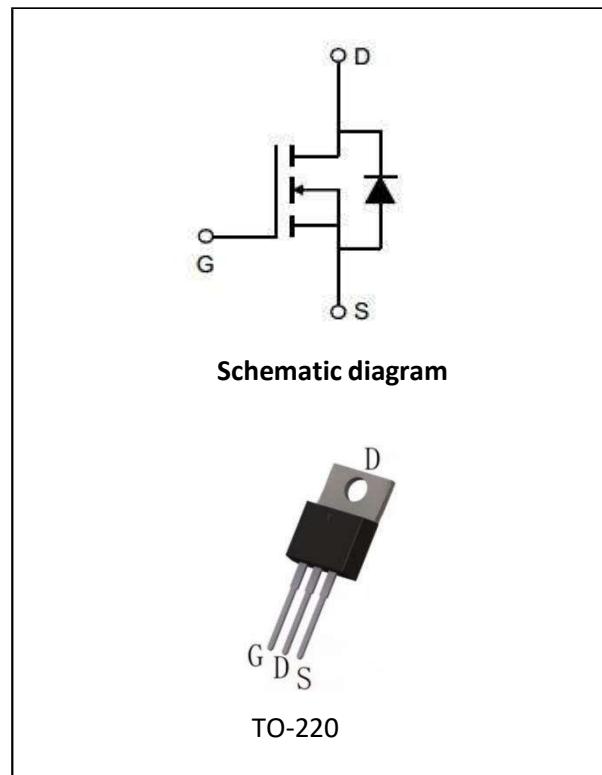
IRF3710, the silicon N-channel Enhanced MOSFETs, is obtained by advanced MOSFET technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. The transistor is suitable device for SMPS, high speed switching and general purpose applications.

FEATURES

- ① $V_{DS}=100V, I_D=70A \quad R_{DS(ON)}<21m\Omega @ V_{GS}=10V$
- ② Fast switching
- ③ 100% avalanche tested
- ④ Improved dv/dt capability

APPLICATIONS

- ① Switch Mode Power Supply(SMPS)
- ② Uninterruptible Power Supply(UPS)
- ③ Power Factor Correction(PFC)

**Package Marking And Ordering Information:**

Ordering Codes	Package	Product Code	Packing
IRF3710	TO-220	IRF3710	Tube

Absolute Maximum Ratings $T_C = 25^\circ C$, unless otherwise noted

Parameter	Symbol	Value	Unit
		TO-220	
Drain-Source Voltage ($V_{GS} = 0V$)	V_{DSS}	100	V
Continuous Drain Current	I_D	70	A
Pulsed Drain Current (note1)	I_{DM}	Figure 6	A
Gate-Source Voltage	V_{GSS}	± 20	V
Single Pulse Avalanche Energy (note2)	E_{AS}	1943	mJ
Avalanche Current (note1)	I_{AR}	32	A
Repetitive Avalanche Energy (note1)	E_{AR}	36	mJ
Power Dissipation ($T_C = 25^\circ C$)	P_D	200	W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 175	°C



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Thermal Resistance							
Parameter	Symbol	Value			Unit		
		TO-220					
Thermal Resistance, Junction-to-Case	R _{thJC}	0.75			°C/W		
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62					
Specifications TJ = 25°C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Value			Unit	
			Min.	Typ.	Max.		
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	100	--	--	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 100V, V _{GS} = 0V, T _J = 25°C	--	--	1	μA	
		V _{DS} = 80V, V _{GS} = 0V, T _J = 125°C	--	--	100		
Gate-Source Leakage	I _{GSS}	V _{GS} = +20V, V _{DS} =0V	--	--	100	nA	
		V _{GS} =-20V, V _{DS} =0V	--	--	-100		
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	2.0	--	4.0	V	
Drain-Source On-Resistance (Note3)	R _{DS(on)}	V _{GS} = 10V, I _D = 28A	--	17	21	mΩ	
Forward Transconductance	g _{fs}	V _{DS} = 10V, I _D = 28A		85		S	
Dynamic							
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 25V, f = 1.0MHz	--	2700	--	pF	
Output Capacitance	C _{oss}		--	610	--		
Reverse Transfer Capacitance	C _{rss}		--	260	--		
Total Gate Charge	Q _g	V _{DD} =50V, I _D = 28A, V _{GS} = 0 to 10V	--	60	--	nC	
Gate-Source Charge	Q _{gs}		--	15	--		
Gate-Drain Charge	Q _{gd}		--	45	--		
Turn-on Delay Time	t _{d(on)}	V _{DD} = 50V, I _D = 28A, V _{GS} = 10V R _G = 2.5 Ω	--	20	--	ns	
Turn-on Rise Time	t _r		--	28	--		
Turn-off Delay Time	t _{d(off)}		--	65	--		
Turn-off Fall Time	t _f		--	15	--		
Drain-Source Body Diode Characteristics							
Continuous Body Diode Current	I _s	T _C = 25 °C	--	--	70	A	
Pulsed Diode Forward Current	I _{SM}		--	--	230		
Body Diode Voltage	V _{SD}	T _J = 25 °C, I _{SD} = 28A, V _{GS} = 0V	--	--	1.5	V	
Reverse Recovery Time	t _{rr}	V _{GS} = 0V, I _s = 28A, dI/dt = 100A /μs	--	195	--	ns	
Reverse Recovery Charge	Q _{rr}		--	107	--	μC	



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Notes

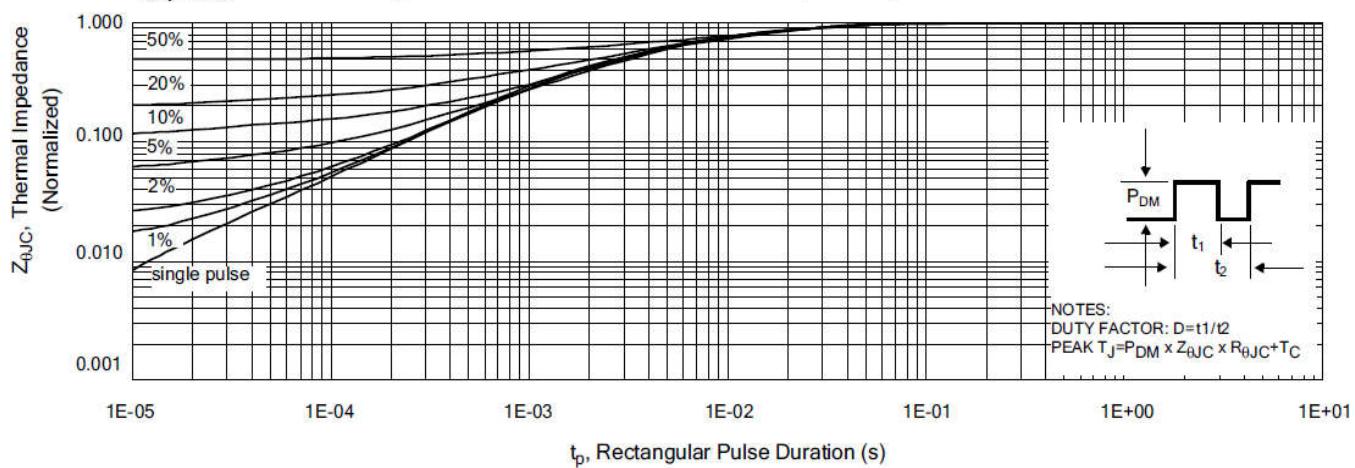
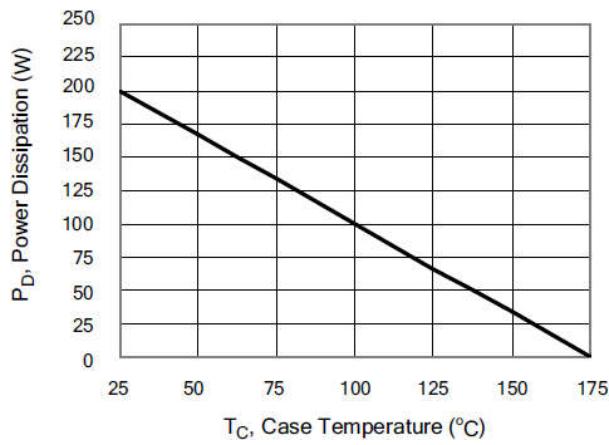
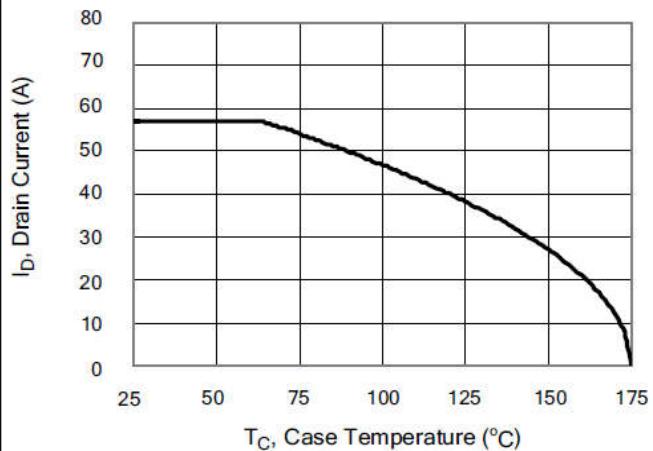
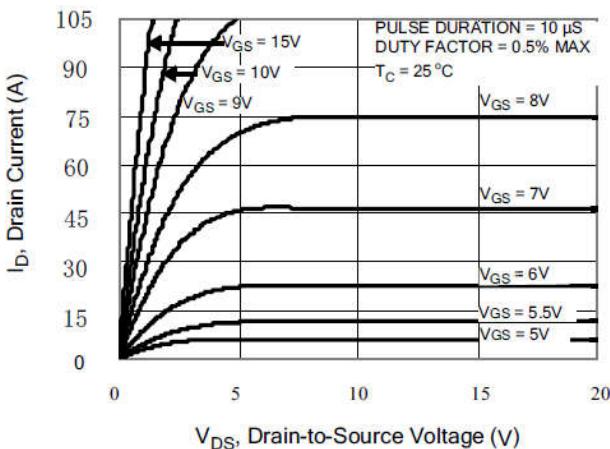
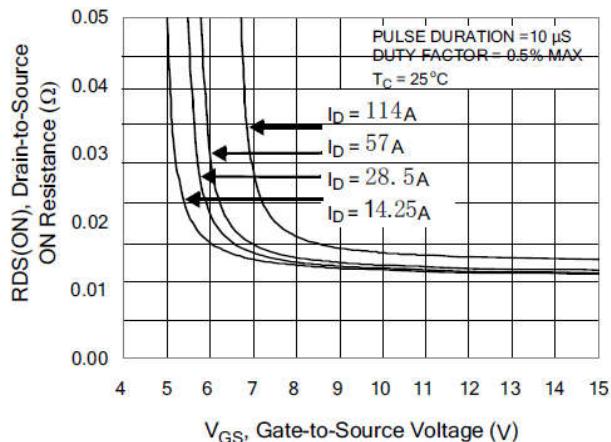
1.Repetitive Rating: Pulse width limited by maximum junction temperature

2. $I_{AS} = 30A$, $V_{DD} = 50V$, $R_G = 25 \Omega$, Starting $T_J = 25^\circ C$

3.Pulse Test: Pulse width $\leq 300\mu s$, Duty Cycle $\leq 1\%$

Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Duty Factor

Figure 1. Maximum Effective Thermal Impedance, Junction-to-Case

Figure 2. Maximum Power Dissipation vs Case Temperature

Figure 3. Maximum Continuous Drain Current vs Case Temperature

Figure 4. Typical Output Characteristics

Figure 5. Typical Drain-to-Source ON Resistance vs Gate Voltage and Drain Current


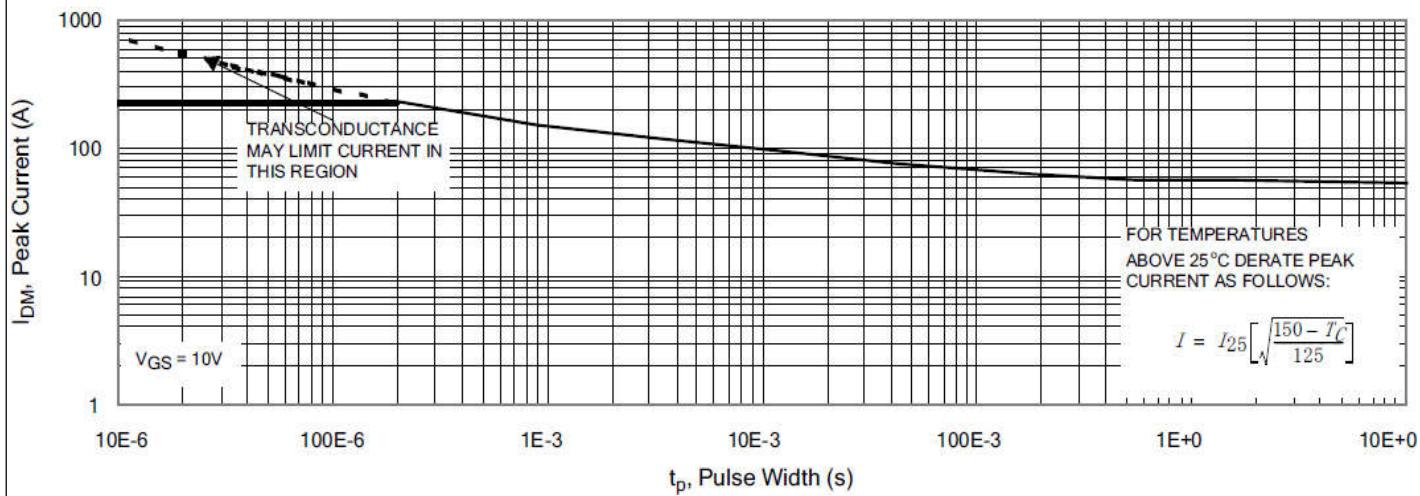
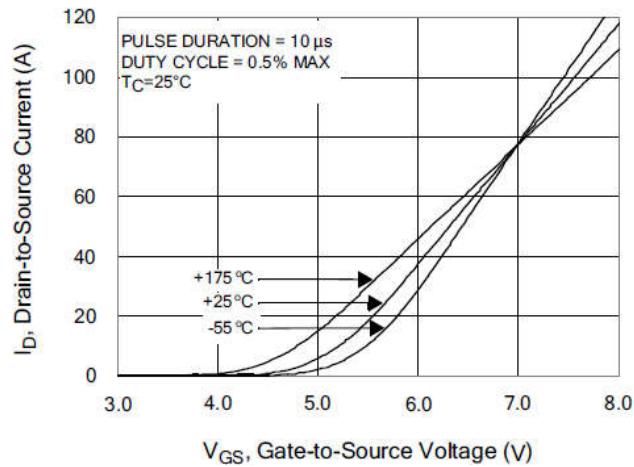
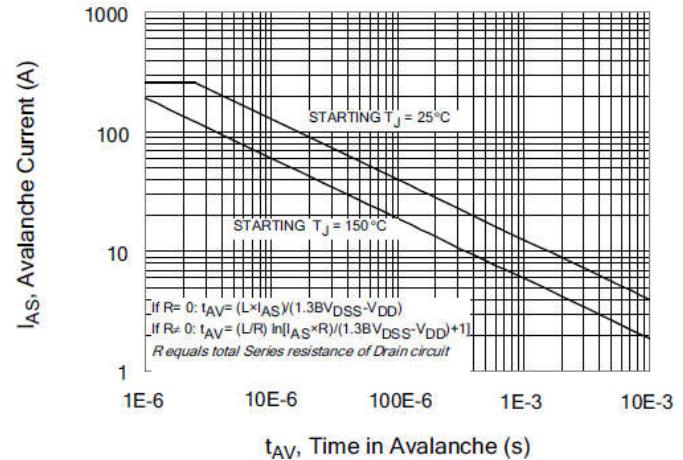
Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted
Figure 6. Maximum Peak Current Capability

Figure 7. Typical Transfer Characteristics

Figure 8. Unclamped Inductive Switching Capability


Figure 9. Typical Drain-to-Source ON Resistance vs Drain Current

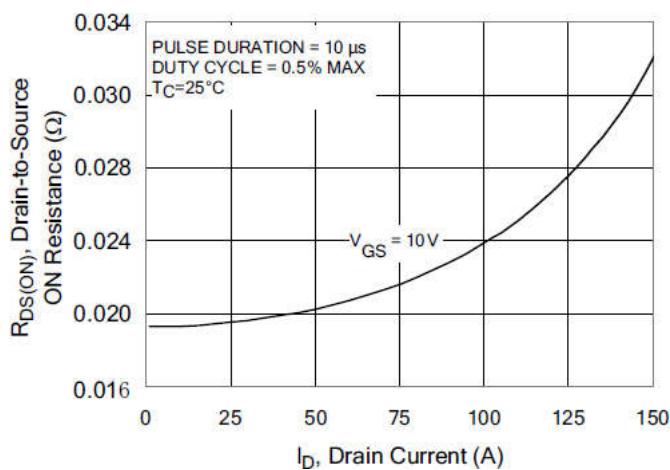
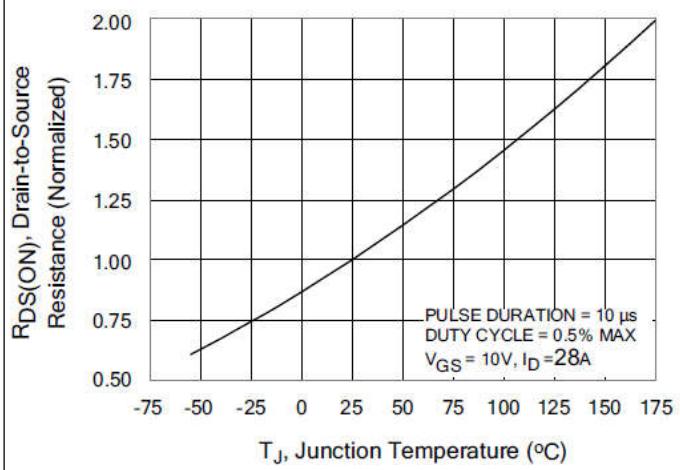


Figure 10. Typical Drain-to-Source ON Resistance vs Junction Temperature



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 11. Typical Breakdown Voltage vs Junction Temperature

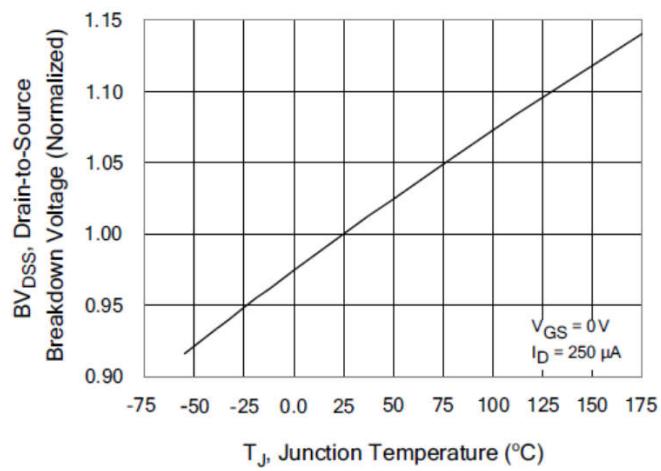


Figure 12. Typical Threshold Voltage vs Junction Temperature

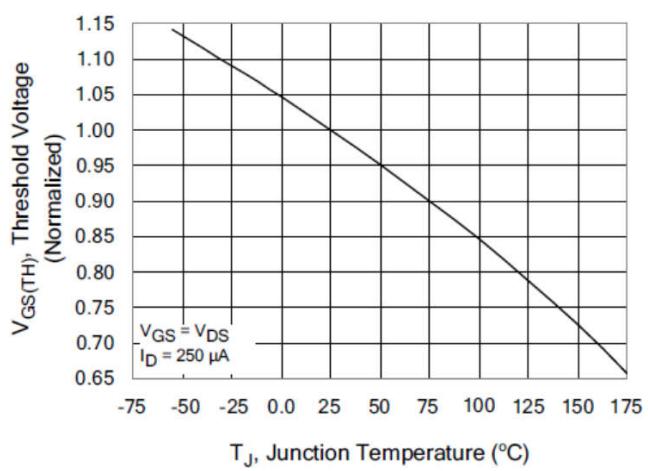


Figure 13. Maximum Forward Bias Safe Operating Area

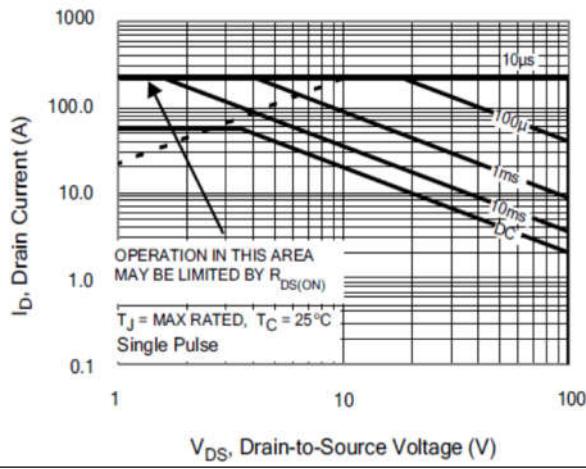


Figure 14. Capacitance vs Vds

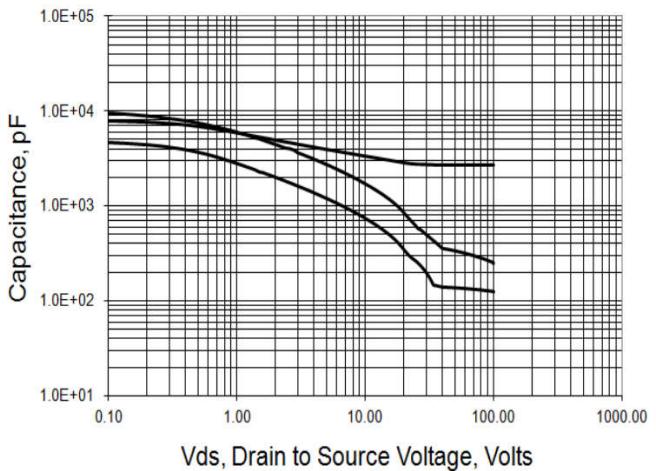


Figure 15 .Typical Gate Charge

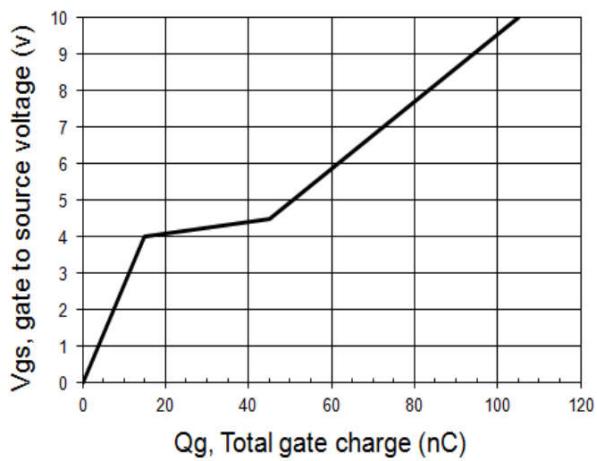


Figure 16. Typical Body Diode Transfer Characteristics

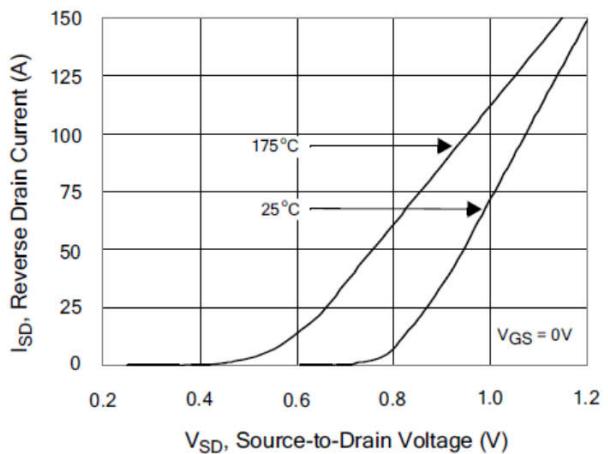
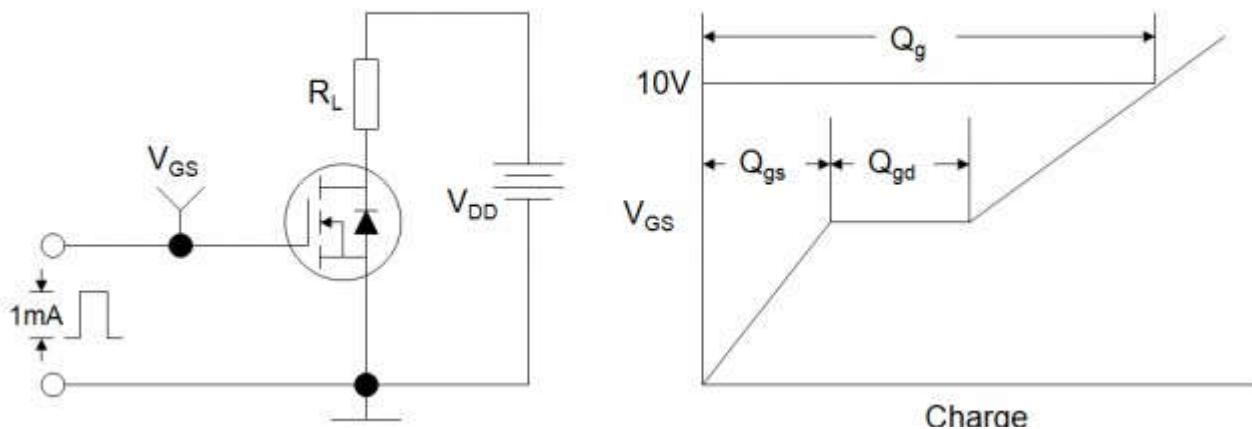
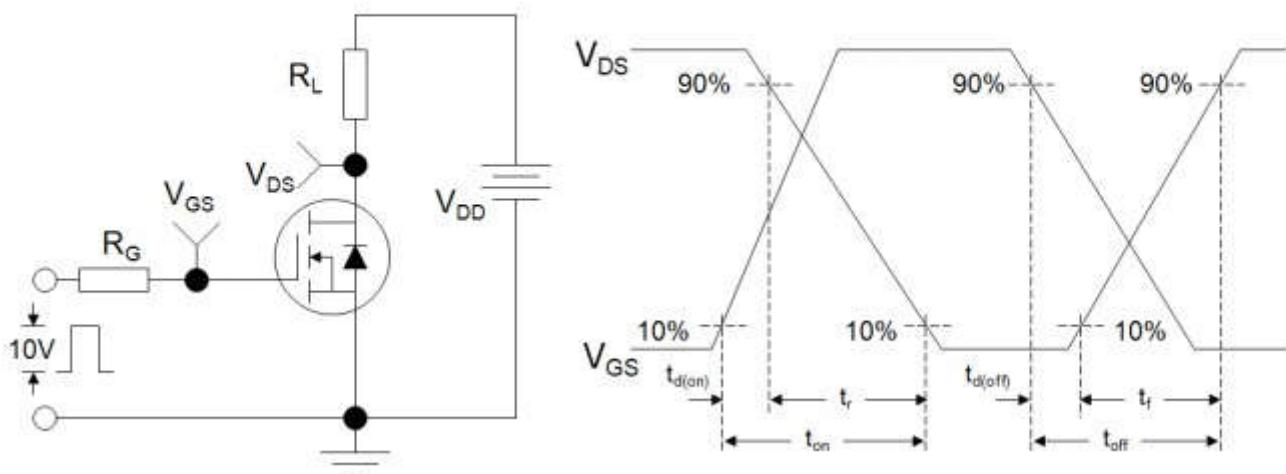
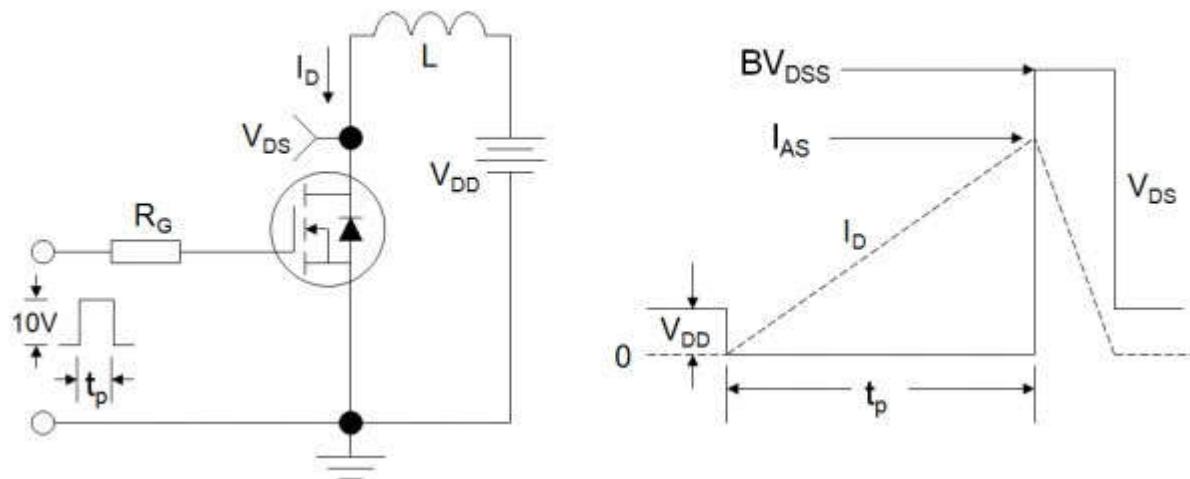
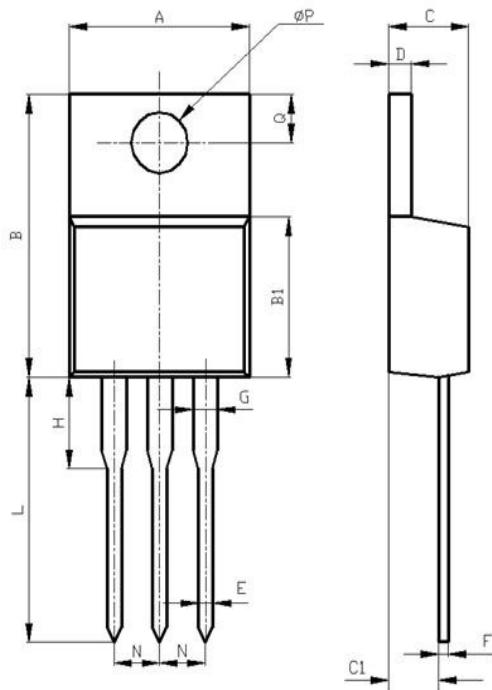


Figure A: Gate Charge Test Circuit and Waveform

Figure B: Resistive Switching Test Circuit and Waveform

Figure C: Unclamped Inductive Switching Test Circuit and Waveform


Package Description



Items	Values(mm)	
	MIN	MAX
A	9.60	10.6
B	15.0	16.0
B1	8.90	9.50
C	4.30	4.80
C1	2.30	3.10
D	1.20	1.40
E	0.70	0.90
F	0.30	0.60
G	1.17	1.37
H	2.70	3.80
L	12.6	14.8
N	2.34	2.74
Q	2.40	3.00
φP	3.50	3.90

TO-220 Package



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NOTE:

1. Exceeding the maximum ratings of the device in performance may cause damage to the device, even the permanent failure, which may affect the dependability of the machine. Please do not exceed the absolute maximum ratings of the device when circuit designing.
2. When installing the heat sink, please pay attention to the torsional moment and the smoothness of the heat sink.
3. MOSFETs is the device which is sensitive to the static electricity, it is necessary to protect the device from being damaged by the static electricity when using it.
4. Shenzhen Minos reserves the right to make changes in this specification sheet and is subject to change without prior notice.

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